

FORM PTO-1449  
INFORMATION DISCLOSURE  
STATEMENT



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APPLICANT(S):

Daniel F. Baldwin, et al.

FILING DATE:

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1764

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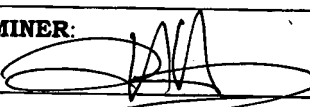
UNITED STATES PATENT DOCUMENTS

EXAM. INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE IF APPROPRIATE
D.H.	AA	3,227,664	01/04/66	Blades et al.			
D.H.	AB	3,227,784	01/04/66	Blades et al.			
D.H.	AC	3,796,779	03/12/74	Greenberg			
D.H.	AD	4,390,332	06/28/93	Hendry			
D.H.	AE	4,424,287	01/03/84	Johnson et al.			
D.H.	AF	4,455,272	06/19/84	Schubert et al.			
D.H.	AG	4,473,665	09/25/84	Martini-Vvedensky et al.			
D.H.	AH	4,548,775	10/22/85	Hayashi et al.			
D.H.	AI	4,628,559	03/01/88	Hardenbrook et al.			
D.H.	AJ	4,719,246	01/19/88	Murdoch et al.			
D.H.	AK	4,728,559	03/01/88	Hardenbrook et al.			
D.H.	AL	4,746,477	05/24/88	Wecker et al.			
D.H.	AM	4,761,256	08/02/88	Hardenbrook et al.			
D.H.	AN	4,832,881	05/23/89	Arnold, Jr., et al.			
D.H.	AO	4,873,218	10/10/89	Pekala et al.			
D.H.	AP	4,906,672	03/06/90	Stone et al.			
D.H.	AQ	5,064,587	11/12/91	Meyke et al.			
D.H.	AR	5,120,559	06/09/92	Rizvi et al.			
D.H.	AS	5,160,674	11/03/92	Colton et al.			
D.H.	AT	5,250,577	10/05/93	Welsh			
D.H.	AU	5,266,605	11/30/93	Welsh			

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FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION YES/NO
D.H.	BA	EP 0376064 A2	04/07/90	Miyakawa et al.			
D.H.	BB	EP 0707935 A2	04/24/96	Baumgart			
D.H.	BC	WO 92/17533	10/15/92	Cha et al.			
D.H.	BD	WO 90/07546	07/12/90	Chum et al.			
D.H.	BE	WO 95/24440	09/14/95	Sanvasi			

<b>FORM PTO-1449</b> <b>INFORMATION DISCLOSURE</b> <b>STATEMENT</b>		<b>DOCKET NO.:</b> 470257/40535-RE-C	<b>SERIAL NO.:</b> 10/082,044
		<b>APPLICANT(S):</b> Daniel F. Baldwin, et al.	
		<b>FILING DATE:</b> February 22, 2002	<b>GROUP NO.:</b> 1764
<b>OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)</b>			
<b>EXAM. INITIALS</b>			
D.H.	CA	Baldwin, D.F., et al., "A PROCESSING SYSTEM FOR THE EXTRUSION OF MICROCELLULAR POLYMER SHEETS:..." Cellular and Microcellular Materials, MD-vol. 53:85-107 (ASME 1994).	
D.H.	CB	LeMay, J.D., et al. "LOW DENSITY MICROCELLAR MATERIAL," MRS Bulletin, December 1990, pp 19-45.	
D.H.	CC	Cha, S.W., "A MICROCELLULAR FOAMING/FORMING PROCESS PERFORMED AT AMBIENT TEMPERATURE AND A TEMPERATURE AND A SUPER-MICROCELLULAR FOAMING PROCESS," (M.I.T.) 1994).	
D.H.	CD	Baldiwn, D.F., "MICROCELLULAR POLYMER PROCESSING AND THE DESIGN OF A CONTINUOU SHEET PROCESSING SYSTEM," Chapter *, pp. 204-205, and 241, (M.I.T. 1994).	
D.H.	CE	Park, C.B., "THE ROLE OF POLYMER/GAS SOLUTIONS IN CONTINUOUS PROCESSING OF MICROCELLULAR POLYMERS," Ch VII, pp. 128-130.	
<b>EXAMINER:</b>		<b>DATE:</b>	
		4-14-6	

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